DRIVENETS

DATASHEET

OPTICAL TRANSCEIVER · OSFP112 RIDING HEAT SINK

DriveNets 800G DR4

OSFP112 transceiver with a single MPO-12 interface and riding heat sink, delivering 4 × 212.5 Gbps PAM4 over single-mode fiber from eight 53.125 GBd host lanes for 800GbE and AI cluster interconnect.

800 Gbps

AGGREGATE LINE RATE

4 × 212.5G PAM4

MPO-12 · 500 m

12 W maximum



OVERVIEW

The DriveNets 800G OSFP112 DR4 is a small-form-factor, hot-pluggable optical transceiver that transmits and receives serial optical data at up to 212.5 Gbps per channel using PAM4 modulation over single-mode fiber. Eight 53.125 GBd host electrical lanes are carried by a PAM4 DSP onto four 106.25 GBd optical lanes presented on an MPO-12 interface with an 8° APC endface, giving 800 Gbps of aggregate capacity at reaches up to 500 m. The module integrates a high-performance silicon-photonics modulator and a riding heat sink (RHS) in an OSFP112 form factor, and is compliant with 800G Ethernet specifications - IEEE P802.3dj D3.0 and IEEE Std 802.3ck-2022 - the OSFP MSA rev 5.2 and OIF-CMIS 5.3 management. Maximum power consumption is 12 W across a 0 °C to +70 °C case-temperature range, suiting AI cluster interconnection, 800GBASE-DR4 Ethernet, datacenters and other 800G interconnect.

Optical interface

MPO-12, 8° APC · 4 lanes at 212.5 Gbps PAM4

1304.5 - 1317.5 nm · 500 m over single-mode fiber

Class 1 laser product per IEC 60825-1

Electrical & management

60-contact edge connector · 8 × 53.125 GBd host lanes

2-wire serial (SCL / SDA) · OIF-CMIS 5.3 memory map

IEEE Std 802.3ck-2022 host electrical compliance

Power & environmental

12 W maximum power consumption · 3.3 V supply

0 °C to +70 °C case · riding heat sink (RHS)

RoHS II 2011/65/EU · digital diagnostics monitoring

HARDWARE SPECIFICATION

Key specifications

Ordering & package

Part number	**DNOT00017**
Form factor	**OSFP112, riding heat sink**
Optical interface	**MPO-12, 8° APC**
Data rate	**800G (4 × 212.5 Gbps PAM4)**
Reach	**500 m single-mode fiber**

Electrical

Supply voltage (VCC)	**3.135 – 3.465 V**
Line-side baud rate	**106.25 GBd ±50 ppm**
Host-side baud rate	**53.125 GBd ±100 ppm**
Power consumption	**12 W maximum**
Output voltage, long mode	**845 mVpp max**
Effective return loss	**8.5 dB min (TP1 / TP4)**
Eye height / VEC	**15 mV min / 12 dB max**

Optical – transmitter

Modulation format	**PAM4**
Lane wavelength	**1304.5 – 1317.5 nm**
Output power (PAVG)	**-3.1 to 4 dBm**
OMAouter, TDECQ < 0.9 dB	**-0.1 to 4.2 dBm**
TDECQ / TECQ, max	**3.4 dB**
Side-mode suppression	**30 dB min**
Extinction ratio	**3.5 dB min**

Environmental

Operating case temp	**0 °C – 70 °C**
Storage temperature	**-40 °C – +85 °C**
Relative humidity	**5% – 85%**
VCC absolute maximum	**-0.3 V – +3.6 V**
Cooling	**Riding heat sink (RHS)**

Optical – receiver

Average receive power	**-6.1 to 4 dBm**
Sensitivity (OMAouter)	**-3.4 dBm**
Stressed sensitivity	**-0.9 dBm**
Damage threshold	**5 dBm per lane**
Receiver reflectance	**-26 dB max**

Management

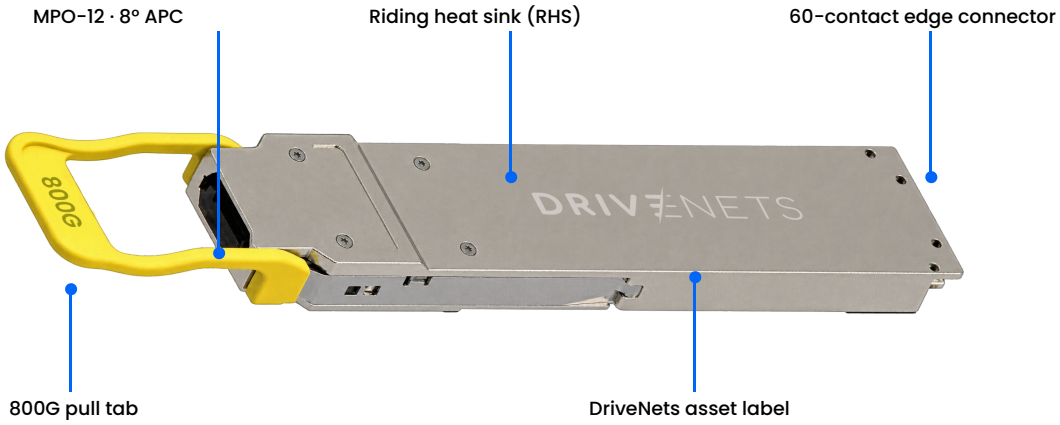
Host interface	**60-contact edge connector**
Control	**2-wire serial (SCL / SDA)**
Memory map	**OIF-CMIS 5.3**

DDM accuracy

Temperature	**±3 °C**
Supply voltage	**±0.1 V**
Tx bias current, per lane	**±10%**
Tx output power, per lane	**±3 dB**
Rx receive power, per lane	**±3 dB**

INTERFACE OVERVIEW

Module layout



REGULATORY COMPLIANCE

Certifications

EMC

FCC 47 CFR Part 15, Class B

EN 55032:2015+A11:2020+A1:2020

EN 55035:2017+A11:2020

IEC 61000-4-3:2020

IEC EN 61000-4-2:2008

Product safety

CB: IEC 62368-1:2018

TÜV Mark: EN IEC 62368-1:2020+A11

UL Recognized Component: UL 62368-1:2019 R10.21, CSA C22.2 No. 62368-1:19

Optical & environmental

Class 1 laser product

FDA/CDRH

IEC 60825-1:2014

IEC 60825-2:2021

EN 60825-1:2014+A11

Complies with RoHS II Directive 2011/65/EU

800 Gbps
AGGREGATE LINE RATE

4 × 212G
PAM4 OPTICAL LANES

500 m
REACH OVER SMF

12 W
MAXIMUM POWER

APPLICATIONS & STANDARDS

Applications

- AI cluster interconnection
- 800GBASE-DR4 Ethernet
- Datacenters
- Other 800G interconnect

Reference documents

- OIF-CMIS-05.3 - common management interface specification (CMIS) rev 5.3
- OSFP MSA specification for OSFP octal small form factor pluggable module rev 5.2
- IEEE P802.3dj™-D3.0
- IEEE Std 802.3ck™-2022

RATINGS

Absolute maximum ratings

PARAMETER	SYMBOL	MIN	MAX	UNIT
Storage temperature range	T_S	**-40**	**+85**	°C
Relative humidity	RH	**5**	**85**	%
Power supply voltage	V_{CC}	**-0.3**	**+3.6**	V
Rx damage threshold, per lane			**5**	dBm

1. Modules operating outside of this range may get permanently damaged.

OPERATING CONDITIONS

Recommended operating conditions

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Operating case temperature	T_C	**0**	**-**	**70**	°C
Power supply voltage	V_{CC}	**3.135**	**3.3**	**3.465**	V
Line-side baud rate, per channel	BR	**106.25 -50 ppm**	**106.25**	**106.25 +50 ppm**	GBd
Host-side baud rate, per channel	BR	**53.125 -100 ppm**	**53.125**	**53.125 +100 ppm**	GBd

1. Modules operating outside of this range do not have the performance guaranteed.

MONITORING

DDM accuracy

PARAMETER	ACCURACY	UNIT	CALIBRATION
Temperature	**±3**	°C	Internal
Voltage	**±0.1**	V	Internal
Tx bias current, each lane	**±10**	%	Internal
Tx output power, each lane	**±3**	dB	Internal
Rx receive power, each lane	**±3**	dB	Internal

MANAGEMENT

Memory map

Refer to OIF-CMIS - common management interface specification (CMIS).

Optical characteristics

The following optical characteristics are defined over the recommended operating conditions unless otherwise specified.

PARAMETER	SYMBOL	MIN	TYPICAL	MAX	UNIT	NOTES
Link power budgets						
Power budget (for max TDECQ)				**6.7**	dB	
Operating distance				**500**	m	
Channel insertion loss				**3**	dB	
Allocation for penalties (for max TDECQ)				**3.7**	dB	
Additional insertion loss allowed				**0**	dB	
Maximum discrete reflectance				**-35**	dB	
Transmitter (per lane)						
Signaling speed		**106.25 -50 ppm**	**106.25**	**106.25 +50 ppm**	GBd	
Modulation format	MF		**PAM4**			
Lane wavelength		**1304.5**	**-**	**1317.5**	nm	
Side-mode suppression ratio	SMSR	**30**			dB	
Optical output power	P_{AVG}	**-3.1**		**4**	dBm	1, 2
Outer OMA, for TDECQ < 0.9 dB	OMA_{outer}	**-0.1**		**4.2**	dBm	
Outer OMA, for 0.9 dB < TDECQ < 3.4 dB	OMA_{outer}	**-1.0 + Max (TECQ, TDECQ)**		**4.2**	dBm	
Transmitter and dispersion eye closure for PAM4	TDECQ			**3.4**	dB	
Transmitter eye closure for PAM4	TECQ			**3.4**	dB	
| TDECQ - TECQ |				**2.5**	dB	
$TDECQ_{CER}$, each lane				**4.4**	dB	
Transmitter functional symbol error histogram, each lane		See IEEE P802.3dj_D3p0 Table 180-18			-	
Transmitter overshoot and undershoot				**22**	%	
Transmitter power excursion				**2.3**	dB	

PARAMETER	SYMBOL	MIN	TYPICAL	MAX	UNIT	NOTES
Extinction ratio	ER	**3.5**			dB	
Transmitter transition time				**8**	ps	
Average launch power of OFF transmitter				**-15**	dBm	
$RIN_{21.4}OMA$				**-139**	dB/Hz	
Optical return loss tolerance				**21.4**	dB	
Transmitter reflectance				**-26**	dB	3
Receiver (per lane)						
Signaling speed per lane		**106.25 -50 ppm**	**106.25**	**106.25 +50 ppm**	GBd	
Modulation format	MF		**PAM4**			
Lane wavelength		**1304.5**	**-**	**1317.5**	nm	
Damage threshold, each lane		**5**			dBm	4
Average receive power, each lane		**-6.1**		**4**	dBm	5
Receive power (OMA_{outer}), each lane				**4.2**	dBm	
Receiver sensitivity (OMA_{outer}), TECQ < 0.9 dB				**-3.4**	dBm	6
Receiver sensitivity (OMA_{outer}), 0.9 dB ≤ TECQ ≤ 3.4 dB				**-4.3 + TECQ**	dBm	6
Receiver reflectance	RR			**-26**	dB	
Stressed receiver sensitivity (OMA_{outer})	SRS			**-0.9**	dBm	6
Conditions of the stressed receiver sensitivity test						
Stressed eye closure for PAM4 (SECQ), lane under test			**3.4**		dB	7, 8
OMA_{outer} of each aggressor lane			**4.2**		dBm	7, 8

1. Average launch power, each lane (min) is not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance.
2. An average launch power of -3.1 dBm corresponds to an OMA of -0.1 dBm with an infinite extinction ratio.
3. Transmitter reflectance is defined looking into the transmitter.
4. The receiver shall be able to tolerate, without damage, continuous exposure to an optical input signal having this average power level. The receiver does not have to operate correctly at this input power.
5. Average receive power, each lane (min) is not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance.
6. Measured with conformance test signal at TP3 (see 180.8) for the BLER specified in 180.2.
7. These test conditions are for measuring stressed receiver sensitivity. They are not characteristics of the receiver.
8. No aggressors needed for 200GBASE-DR1 in a single lane device.

ELECTRICAL

Electrical characteristics

The following electrical characteristics are defined over the recommended operating conditions unless otherwise specified.

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	NOTES
Supply voltage	V_{CC}	**3.135**		**3.465**	V	
Power consumption	PC			**12**	W	
Module input						
Differential pk-pk voltage tolerance		**750**			mV	TP1a
Peak-to-peak AC common-mode voltage tolerance, low-frequency	V_{CMLF}	**32**			mV	TP1a
Peak-to-peak AC common-mode voltage tolerance, full-band	V_{CMFB}	**80**			mV	TP1a
Differential-mode to common-mode return loss	RL_{cd}	See IEEE Std 802.3ck™-2022 Equation (120G-2)			dB	TP1
Effective return loss	ERL	**8.5**			dB	TP1
Differential termination mismatch				**10**	%	TP1
Module stressed input tolerance		See IEEE Std 802.3ck™-2022 120G.3.4.3				TP1a
Single-ended voltage tolerance range		**-0.4**		**3.3**	V	TP1a
DC common-mode voltage tolerance		**-0.35**		**2.85**	V	TP1
Module output						
Differential peak-to-peak output voltage, short mode				**600**	mV	TP4
Differential peak-to-peak output voltage, long mode				**845**	mV	TP4
Peak-to-peak AC common-mode voltage, low-frequency	V_{CMLF}			**32**	mV	TP4
Peak-to-peak AC common-mode voltage, full-band	V_{CMFB}			**80**	mV	TP4
Eye height		**15**			mV	TP4
Vertical eye closure, VEC				**12**	dB	TP4
Common-mode to differential-mode return loss	RL_{dc}	See IEEE Std 802.3ck™-2022 Equation (120G-1)			dB	TP4
Effective return loss	ERL	**8.5**			dB	TP4
Differential termination mismatch				**10**	%	TP4
Transition time		**8.5**			ps	TP4
DC common-mode voltage tolerance		**-0.35**		**2.85**	V	TP4

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	NOTES
Low-speed signals - SCL and SDA (I_{OLmax} = 3 mA)						
Output low voltage	V_{OL}	**0**		**0.4**	V	
Output high voltage	V_{OH}	**V_{CC} - 0.5**		**V_{CC} + 0.3**	V	
Input low voltage	V_{IL}	**-0.3**		**V_{CC} × 0.3**	V	
Input high voltage	V_{IH}	**V_{CC} × 0.7**		**V_{CC} + 0.5**	V	

HOST INTERFACE

Pin assignment

The electrical interface of the OSFP module consists of a 60-contact edge connector, as illustrated in the figure below, which is defined in Clause 8.1 of the OSFP MSA Specification.



Figure 1. OSFP module pinout

SIGNALS

Pin description

NAME	PIN	DIRECTION	DESCRIPTION
TX[8:1]p / TX[8:1]n		Input	Transmit differential pairs from host to module.
RX[8:1]p / RX[8:1]n		Output	Receive differential pairs from module to host.
SCL	14	Bidirectional	2-wire serial clock signal. Requires pull-up resistor to 3.3 V on host.
SDA	47	Bidirectional	2-wire serial data signal. Requires pull-up resistor to 3.3 V on host.
LPWn/PRSn	17	Bidirectional	Multi-level signal for low power control from host to module and module presence indication from module to host.
INT/RSTn	44	Bidirectional	Multi-level signal for interrupt request from module to host and reset control from host to module.
VCC	15, 16, 45, 46	Power	3.3 V power for module.
GND		Ground	Module ground. Logic and power return path.

ARCHITECTURE

Functional block diagram

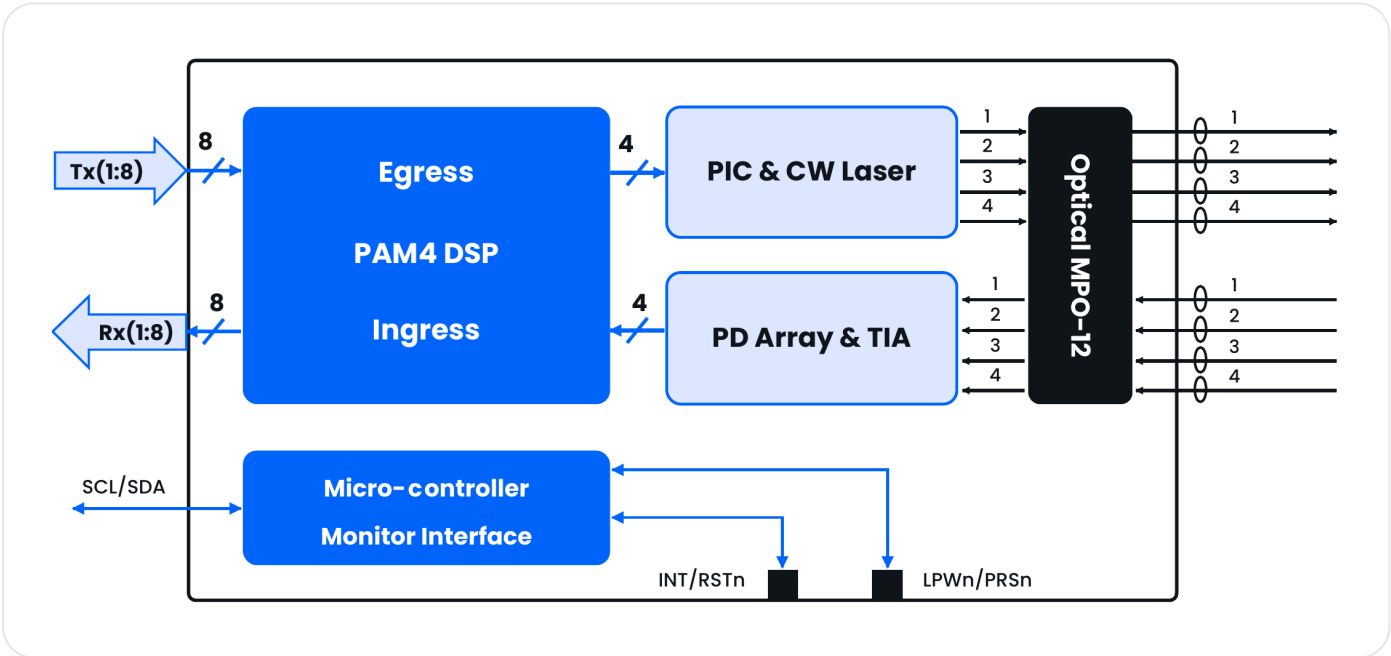


Figure 2. 800G OSFP112 DR4 functional block diagram

COMPLIANCE

Regulatory and compliance

CATEGORY	STANDARD
EMC - immunity	EN 55035:2017+A11:2020 IEC 61000-4-3:2020
EMC - emission	FCC 47 CFR Part 15, Class B EN 55032:2015+A11:2020+A1:2020
ESD threshold	IEC EN 61000-4-2:2008
Product safety	CB: IEC 62368-1:2018 TÜV Mark: EN IEC 62368-1:2020+A11 UL Recognized Component: UL 62368-1:2019 R10.21, CSA C22.2 No. 62368-1:19
Optical safety	Class 1 laser product FDA/CDRH IEC 60825-1:2014 IEC 60825-2:2021 EN 60825-1:2014+A11
RoHS	Complies with RoHS II Directive 2011/65/EU

MECHANICAL

Mechanical package outline

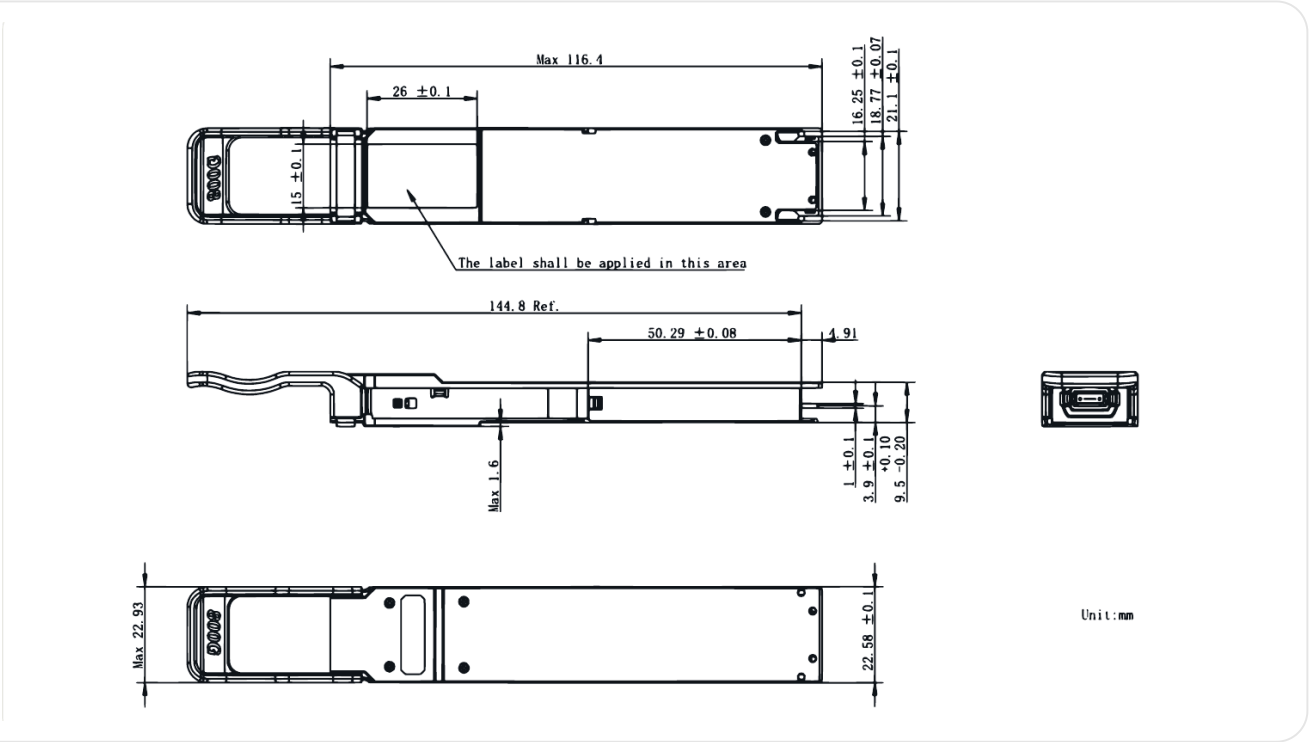
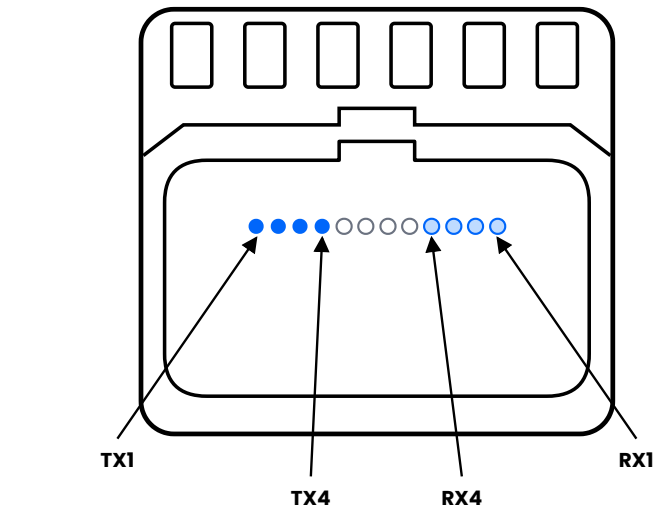


Figure 3. Mechanical package outline (all dimensions are in mm) · Unit: mm.

Optical interface



Channels	Tx1	Tx2	Tx3	Tx4	x	x	x	x	Rx4	Rx3	Rx2	Rx1
(x: unused position)												

Transmit lane Receive lane Unused position

Figure 4. Optical receptacle and channel orientation for MPO-12 connector.
Note: optical interface is 8° APC MPO-12.